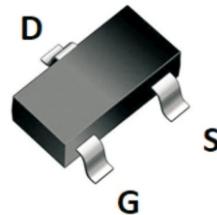




## NM2302C

4.3A 20V N-CHANNEL MOSFET

SOT-23

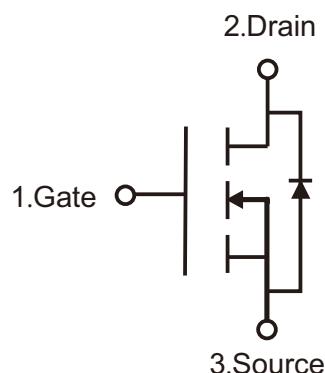


### Features

- $R_{DS(ON)} \leq 30m\Omega$  @  $V_{GS}=4.5V$
- $R_{DS(ON)} \leq 45m\Omega$  @  $V_{GS}=2.5V$
- Advancend Trench Technology
- Excellent  $R_{DC(ON)}$  And Low Gate Charge
- Lead Free Prouduct Is Acquired

### Application

- Load Switch
- PWM Application
- Power Management



### Absolute Maximum Ratings (TA=25°C, unless otherwise specified)

Parameter	Symbols	Ratings	Units
Drain-Source Voltage	$V_{DSS}$	20	V
Gate-Source Voltage	$V_{GSS}$	$\pm 12$	V
Continuous Drain Current	$I_D$	4.3	A
Pulsed Drain Current (Note 2)	$I_{DM}$	16	A
Power Dissipation	$P_D$	0.8	W
Thermal Resistance, Junction to Case	$R_{\theta JA}$	156	°CW
Operation Junction Temperature and Storage Temperature	$T_j, T_{stg}$	-55 ~ +150	°C



**Electrical Characteristics (TA=25°C, unless otherwise specified)**

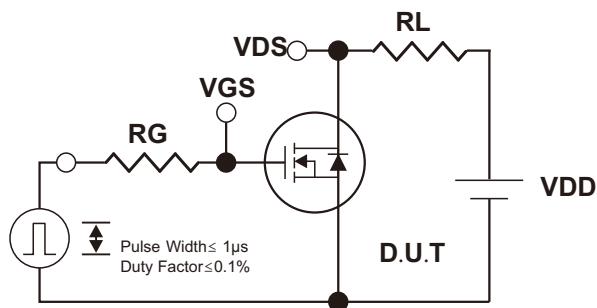
Parameter	Symbols	Test Conditions	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	B <sub>VDSS</sub>	V <sub>GS</sub> =0V,I <sub>D</sub> =250μA	20	22		V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =20V,V <sub>GS</sub> =0V	0.5	0.7	1	uA
Gate- Source Leakage Current	Forward	I <sub>GSS</sub>	V <sub>GS</sub> =12V,V <sub>DS</sub> =0V		100	nA
	Reverse		V <sub>GS</sub> =-12V,V <sub>DS</sub> =0V		-100	
<b>On Characteristics</b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA	0.5	0.7	1.1	V
Static Drain-Source On-State Resistance (Note1)	R <sub>DSON</sub>	V <sub>GS</sub> =4.5V,I <sub>D</sub> =4A		22	30	mΩ
		V <sub>GS</sub> =2.5V,I <sub>D</sub> =3A		30	45	mΩ
<b>Dynamic Characteristics</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =10V, V <sub>GS</sub> =0V, f=1.0MHz		358		pF
Output Capacitance	C <sub>oss</sub>			69.3		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			58.5		pF
<b>Switching Characteristics</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =10V,V <sub>GS</sub> =4.5V, ID=2A		5.6		nC
Gate-Source Charge	Q <sub>gs</sub>			0.8		nC
Gate-Drain Charge	Q <sub>gd</sub>			1		nC
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>DS</sub> =10V,V <sub>GS</sub> =4.5V, ID=4.0A,R <sub>GEN</sub> =3Ω		16		ns
Turn-On Rise Time	t <sub>r</sub>			51		ns
Turn-Off Delay Time	t <sub>d(off)</sub>			21		ns
Turn-Off Fall Time	t <sub>f</sub>			19		ns
<b>Drain-Source Diode Characteristics And Maximum Ratings</b>						
Maximum Body-Diode Continuous Current	I <sub>s</sub>				4	A
Maximum Body-Diode Pulsed Current	I <sub>SM</sub>				16	A
Drain-Source Diode Forward Voltage (Note 1)	V <sub>SD</sub>	I <sub>s</sub> =4A,V <sub>GS</sub> =0V			1.2	V

**Notes:**

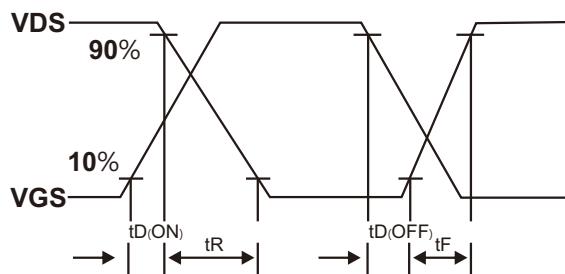
1. Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 0.5%.
2. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature



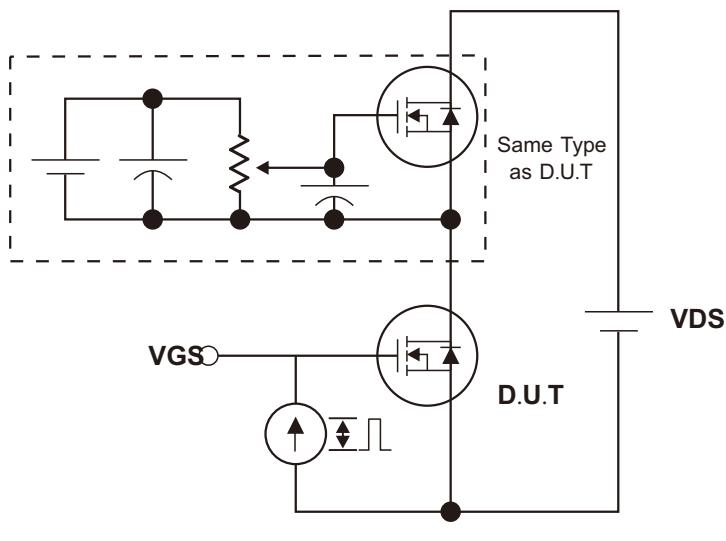
### Test Circuits and waveforms



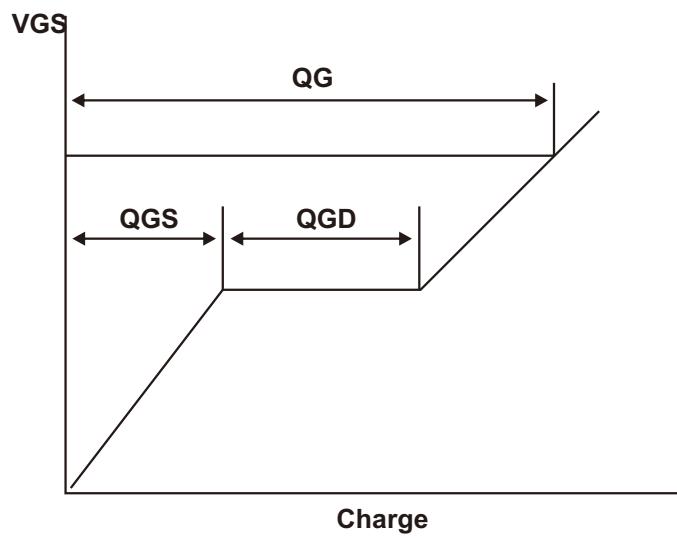
Switching Test Circuit



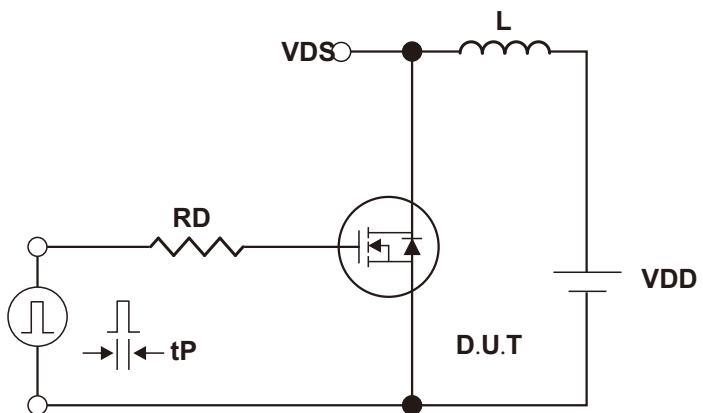
Switching Waveforms



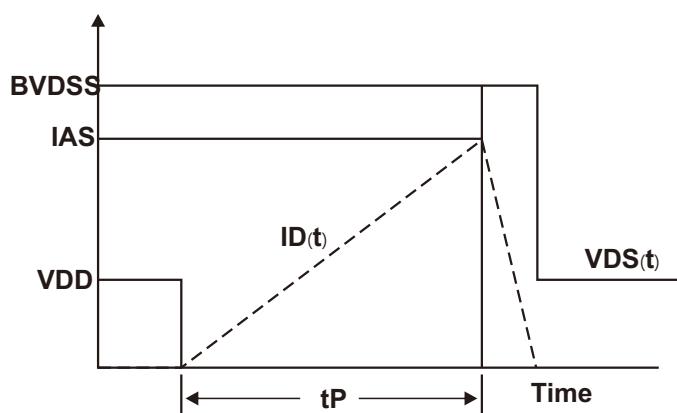
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms



## Typical Characteristics

Fig.1 Output Characteristics

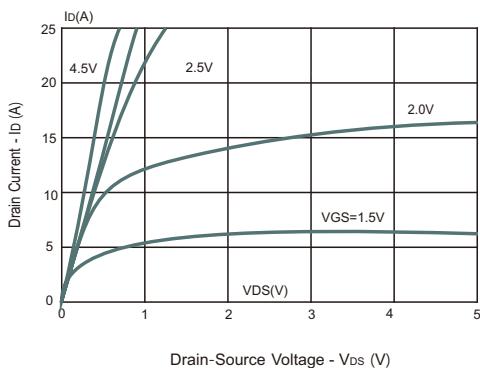


Fig.3 Drain-Source On-Resistance vs. Drain Current

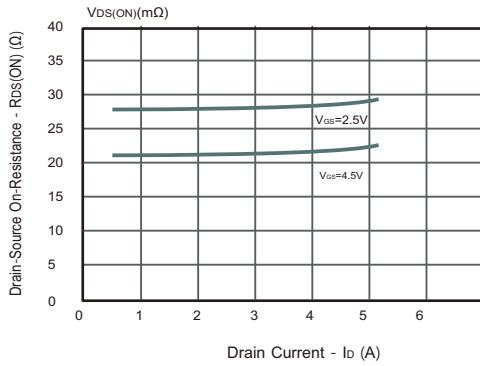


Fig.5 Gate Charge Characteristics

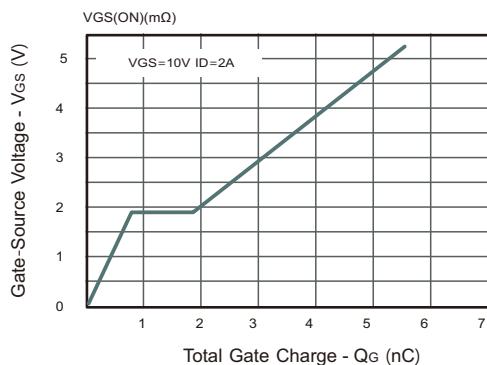


Fig.7 Breakdown Voltage vs. Junction Temperature

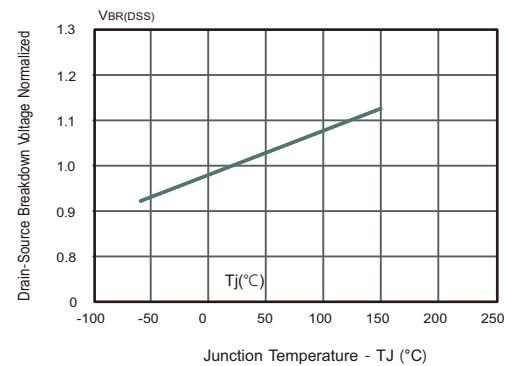


Fig.2 Typical Transfer Characteristics

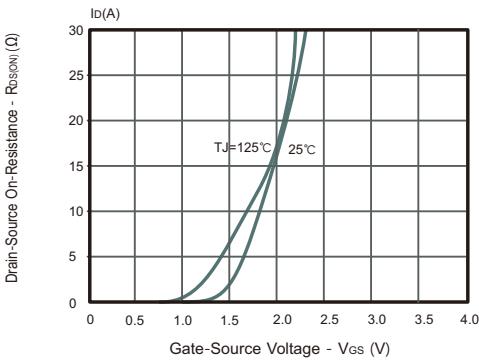


Fig.4 Body Diode Characteristics

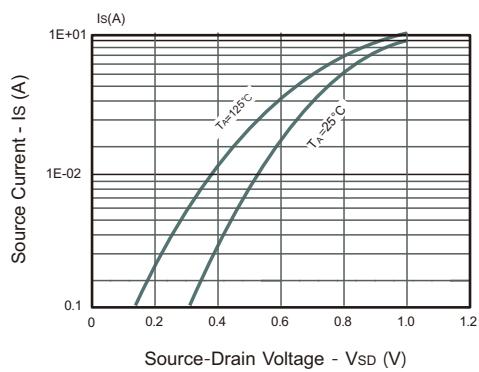


Fig.6 Capacitance Characteristics

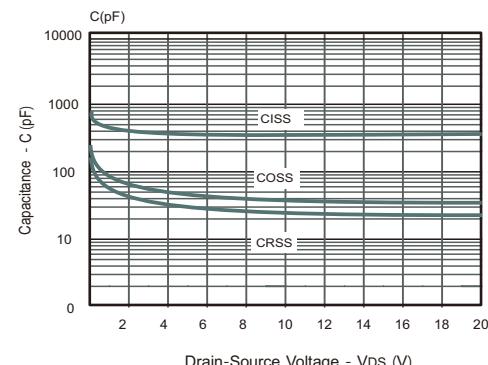
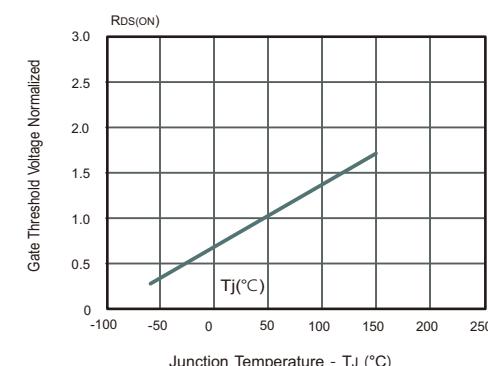


Fig.8 Normalized on Resistance vs. Junction Temperature





## Typical Characteristics

Fig.9 Safe Operating Area

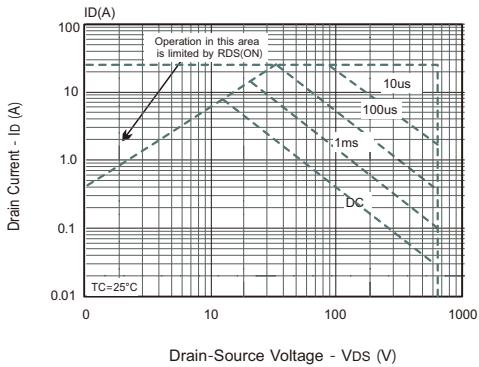
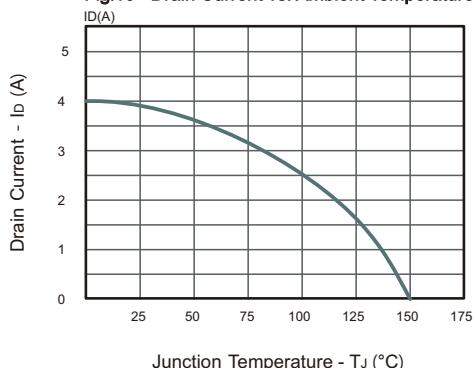
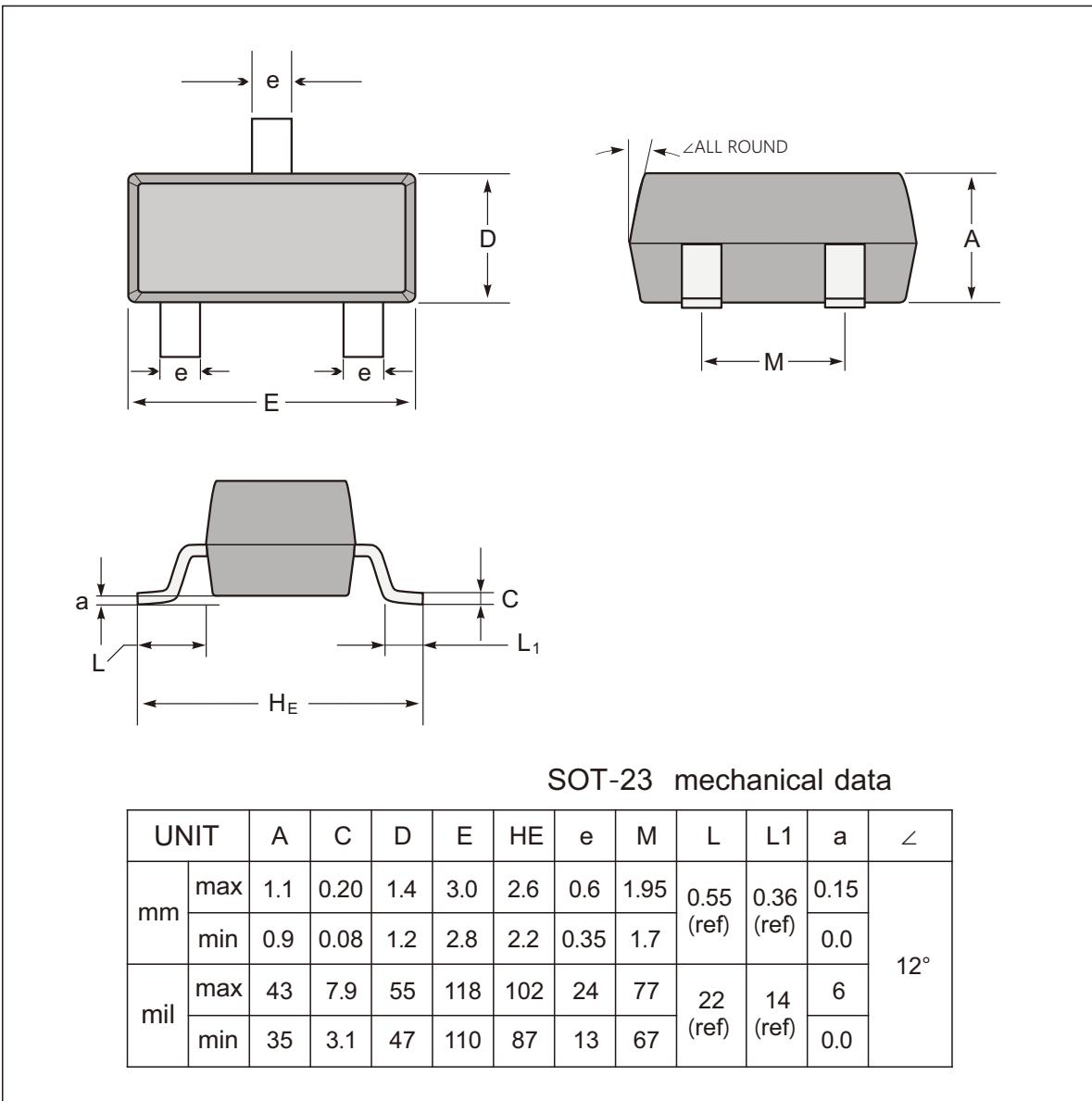


Fig.10 Drain Current vs. Ambient Temperature

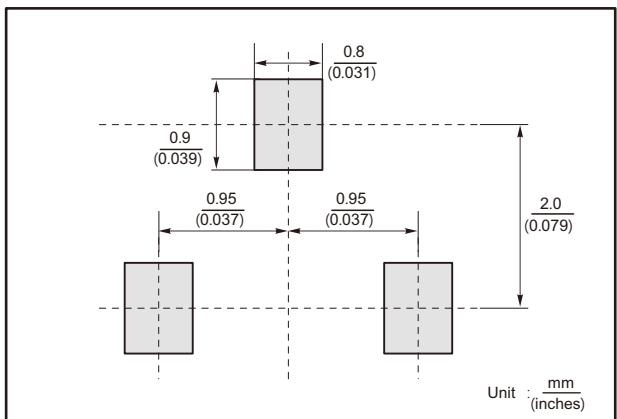




### SOT-23 Package Outline Dimensions



The recommended mounting pad size



Marking

Type number	Marking code
NM2302C	2302C



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